SEARAY

SEAM-30-03.5-S-04-2-A-K-TR

SEAM-20-02.0-S-10-2-A-K-TR SEAM-30-02.0-S-08-2-A-K-TR

(1.27 mm) .050"

SEAM SERIES

GH-SPEED/HIGH-DENSITY OPEN-PIN-FI

SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?SEAM

Insulator Material: Black I CF Contact Material: Copper Alloy Operating Temp Range: -55 °C to +125 °C Current Rating (7 mm stack height): 1.8 A per pin (10 adjacent pins powered) Plating: Au or Sn over 50 μ" (1.27 μm) Ni Contact Resistance:

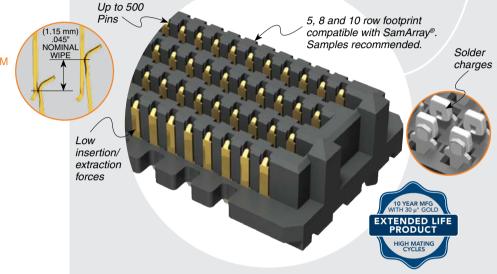
5.5 mΩ Working Voltage: 240 VAC RoHS Compliant: Yes Lead-Free Solderable: Yes

Mates with:

SEAF, SEAFP

Standoffs:

SO, JSO, JSOM



RECOGNITIONS

For complete scope of recognitions see www.samtec.com/quality



STANDARDS

- PISMO 2
- VISTA 57.4

PROTOCOLS

- 100 GbE
- Fiber Channel
- Rapid I/O
- PCI Express[®]
- SATA
- InfiniBand™

MATED HEIGHTS					
SEAM	SEAF LEAD STYLE				
LEAD STYLE	-05.0	-06.0	-06.5		
-02.0	7 mm	8 mm	8.5 mm		
-03.0	8 mm	9 mm	9.5 mm		
-03.5	8.5 mm	9.5 mm	10 mm		
-06.5	11.5 mm	12.5 mm	13 mm		
-07.0	12 mm	13 mm	13.5 mm		
-09.0	14 mm	15 mm	15.5 mm		
-11.0	16 mm	17 mm	17.5 mm		

Notes:

Patented

IPC-A-610F and IPC J-STD-001F Class 3 solder joint.

Some sizes, styles and options are non-standard non-returnable.



NO. PINS PER ROW

-10, -15, -20



Specify

LEAD

STYLE

from

chart

PLATING OPTION

= 10 µ"

(0.25 µm)

Gold on

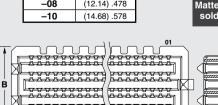
NO. OF **ROWS**

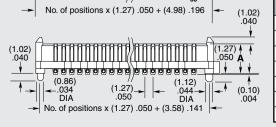
TYPE

SOLDER

- VISTA 47
- VISTA 57.1
- -30, -40, -50 -10 only available in 04 row) (-15 only available in 10 row)

NO. OF ROWS	В	
-04	(7.06) .278	
-05, -06	(9.60) .378	
-08	(12.14) .478	





contact area Matte Tin on solder tail -S

> ₫(1.27) .050 Ď↓

= 30 µ" (0.76 µm) Gold on contact area Matte Tin on solder tail

-04=Four Rows (-06.5 not available)

-05=Five Rows (-06.5 not available)

-06 =Six Rows (-06.5 not available)

-08 =Eight Rows

-10 =Ten Rows

LEAD STYLE	Α	
-02.0	(4.60) .181	
-03.0	(5.59) .220	
-03.5	(6.10) .240	
-06.5	(9.14) .360	
-07.0	(9.60) .378	
-09.0	(11.60) .457	
-11.0	(13.60) .535	

= Tin/Lead Allov Solder Charge

-2 = Lead-Free Solder Charge

–K = Polyimide film Pick & Place Pad

– A

= Alignment Pins

(Required. Arrays

will not self-center

on solder pads)

-TR =Tape & Reel

DIFFERENTIAL

(1	• • •	-(1.27) .050 O O • •	ARRAY	PAIR COUNT
(1.27) O O O O O O			40x8	80
<u></u>		40x6	60	
T •••••		30x10	75	
		PAIR	30x8	60
ı	ARRAY	COUNT	30x6	45
	50x10	125	20x10	50
	50x8	100	20x8	40
I	40x10	100	20x5	25

ALSO AVAILABLE (MOQ Required)

 Up to 560 pins Contact Samtec.